# **One Watt High Current Transistors**

## **PNP Silicon**

### **Features**

• These Devices are Pb-Free and are RoHS Compliant\*

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Collector – Emitter Voltage MPSW51 MPSW51A	V <sub>CEO</sub>	-30 -40	Vdc
Collector - Base Voltage MPSW51 MPSW51A	V <sub>CBO</sub>	-40 -50	Vdc
Emitter - Base Voltage	V <sub>EBO</sub>	-5.0	Vdc
Collector Current – Continuous	I <sub>C</sub>	-1000	mAdc
Total Device Dissipation @ T <sub>A</sub> = 25°C Derate above 25°C	P <sub>D</sub>	1.0 8.0	mW mW/°C
Total Device Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	P <sub>D</sub>	2.5 20	W mW/°C
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

## THERMAL CHARACTERISTICS

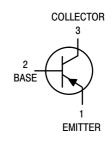
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	125	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	50	°C/W

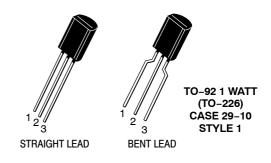
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.



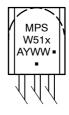
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#### **MARKING DIAGRAM**



x = 51A Devices

A = Assembly Location

Y = Year

WW = Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

## **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

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<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

## **ELECTRICAL CHARACTERISTICS** ( $T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTICS					
Collector – Emitter Breakdown Voltage (Note 1) $(I_C = -1.0 \text{ mAdc}, I_B = 0)$	MPSW51 MPSW51A	V <sub>(BR)CEO</sub>	-30 -40	- -	Vdc
Collector – Base Breakdown Voltage ( $I_C = -100 \mu Adc, I_E = 0$ )	MPSW51 MPSW51A	V <sub>(BR)CBO</sub>	-40 -50	- -	Vdc
Emitter – Base Breakdown Voltage ( $I_E = -100 \mu Adc, I_C = 0$ )		V <sub>(BR)EBO</sub>	-5.0	-	Vdc
Collector Cutoff Current $(V_{CB} = -30 \text{ Vdc}, I_E = 0)$ $(V_{CB} = -40 \text{ Vdc}, I_E = 0)$	MPSW51 MPSW51A	Ісво	- -	-0.1 -0.1	μAdc
Emitter Cutoff Current $(V_{EB} = -3.0 \text{ Vdc}, I_C = 0)$		I <sub>EBO</sub>	-	-0.1	μAdc
ON CHARACTERISTICS					
DC Current Gain $ \begin{array}{l} (I_C = -10 \text{ mAdc, } V_{CE} = -1.0 \text{ Vdc)} \\ (I_C = -100 \text{ mAdc, } V_{CE} = -1.0 \text{ Vdc)} \\ (I_C = -1000 \text{ mAdc, } V_{CE} = -1.0 \text{ Vdc)} \end{array} $		h <sub>FE</sub>	55 60 50	- - -	-
Collector – Emitter Saturation Voltage (I <sub>C</sub> = -1000 mAdc, I <sub>B</sub> = -100 mAdc)		V <sub>CE(sat)</sub>	-	-0.7	Vdc
Base – Emitter On Voltage (I <sub>C</sub> = -1000 mAdc, V <sub>CE</sub> = -1.0 Vdc)		V <sub>BE(on)</sub>	-	-1.2	Vdc
SMALL-SIGNAL CHARACTERISTICS			•	•	
Current-Gain – Bandwidth Product ( $I_C = -50$ mAdc, $V_{CE} = -10$ Vdc, $f = 20$ MHz)		f <sub>T</sub>	50	-	MHz
Output Capacitance (V <sub>CB</sub> = -10 Vdc, I <sub>E</sub> = 0, f = 1.0 MHz)		C <sub>obo</sub>	-	30	pF

<sup>1.</sup> Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

## **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MPSW51G	TO-92 (Pb-Free)	5000 Units / Bulk
MPSW51AG	TO-92 (Pb-Free)	5000 Units / Bulk
MPSW51RLRAG	TO-92 (Pb-Free)	2000 / Tape & Reel
MPSW51ARLRAG	TO-92 (Pb-Free)	2000 / Tape & Reel
MPSW51ARLRPG	TO-92 (Pb-Free)	2000 / Ammo Pack

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

## **TYPICAL CHARACTERISTICS**

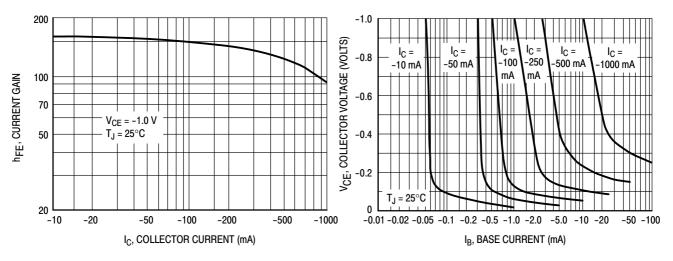


Figure 1. DC Current Gain

Figure 2. Collector Saturation Region

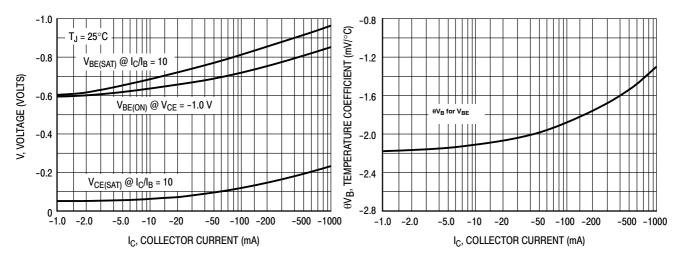


Figure 3. "ON" Voltages

Figure 4. Temperature Coefficient

## **TYPICAL CHARACTERISTICS**

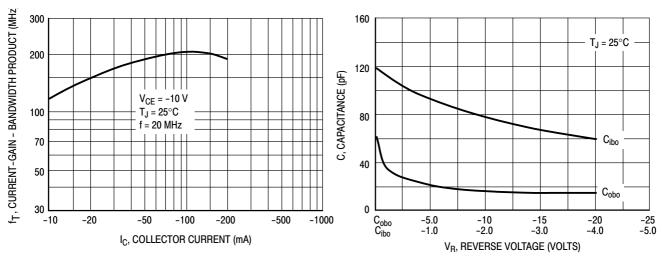


Figure 5. Current Gain — Bandwidth Product

Figure 6. Capacitance

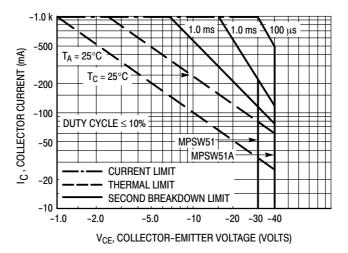
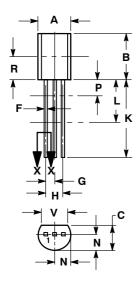


Figure 7. Active Region — Safe Operating Area

#### PACKAGE DIMENSIONS

## TO-92 (TO-226) 1 WATT CASE 29-10 **ISSUE A**



STRAIGHT LEAD



#### NOTES:

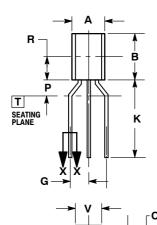
- DIMENSIONING AND TOLERANCING PER ANSI

  - Y14.5M, 1994.
    CONTROLLING DIMENSION: INCHES.
- CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
- DIMENSION F APPLIES BETWEEN DIMENSIONS P AND L. DIMENSIONS D AND J APPLY BETWEEN DI-MENSIONS L AND K MINIMUM. THE LEAD DIMENSIONS ARE UNCONTROLLED IN DIMENSION P AND BEYOND DIMENSION K MINIMUM.

	INC	HES	MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.44	5.21
В	0.290	0.310	7.37	7.87
С	0.125	0.165	3.18	4.19
D	0.018	0.021	0.46	0.53
F	0.016	0.019	0.41	0.48
G	0.045	0.055	1.15	1.39
Н	0.095	0.105	2.42	2.66
L	0.018	0.024	0.46	0.61
K	0.500		12.70	
L	0.250		6.35	
N	0.080	0.105	2.04	2.66
Р		0.100		2.54
R	0.135		3.43	
٧	0.135		3.43	

STYLE 1: PIN 1. EMITTER

BASE COLLECTOR







#### NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: INCHES.
  CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
- DIMENSION F APPLIES BETWEEN DIMENSIONS P AND L. DIMENSIONS D AND J APPLY BETWEEN DIMENSIONS L AND K MINIMUM. THE LEAD DIMENSIONS ARE UNCONTROLLED IN DIMENSION P AND BEYOND DIMENSION K MINIMUM.

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В	0.290	0.310	7.37	7.87
С	0.125	0.165	3.18	4.19
D	0.018	0.021	0.46	0.53
G	0.094	0.102	2.40	2.80
J	0.018	0.024	0.46	0.61
K	0.500		12.70	
N	0.080	0.105	2.04	2.66
Р		0.100		2.54
R	0.135		3.43	
٧	0.135		3.43	

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